







# High-Reliability Gas Sensor Sockets for Nissha FIS, Inc.



Nissha FIS, Inc.



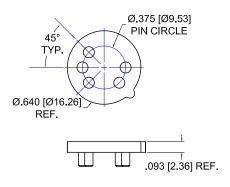
Featuring Andon's Unique Senstac Contact



## **Sockets**



Nissha FIS, Inc.											
Nissha FIS, Inc. Sensor Number	Andon Part Number Replace "XXX" with Terminal Type	Terminal Type Surface Mount		Pin Ø [in]	Figure Number	Page Number					
EC-570	R500-SP01-02N-XXX-R27-L14	018	938	.018	2	1					
SB-AQ1-06	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-11A-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-12A-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-15-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-19-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-30-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-42A-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-43A-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-53-01	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-95-12	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SB-500-12	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SP3-61-00	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SP3S-AQ2-01	R400-SP03-02N-XXX-R27-L14	295V	439V	.030	3	1					
SP-11-00	R375-0805-01T-XXX-R27-L14	433E	285E	.040	1	1					
SP-31-00	R375-0805-01T-XXX-R27-L14	433E	285E	.040	1	1					
SP-42A-00	R375-0805-01T-XXX-R27-L14	433E	285E	.040	1	1					
SP-42AF-00	R375-0805-01T-XXX-R27-L14	433E	285E	.040	1	1					



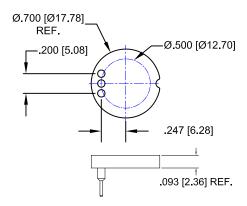
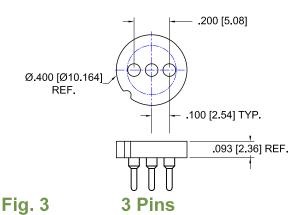


Fig. 1 5 Pins

Thru-Hole: R375-0805-01T-433E-R27-L14
Surface Mount: R375-0805-01T-285E-R27-L14

Fig. 2 3 Pins

Thru-Hole: R500-SP01-02N-01S-R27-L14
Surface Mount: R500-SP01-02N-93S-R27-L14



Thru-Hole: R400-SP03-02N-295V-R27-L14 Surface Mount: R400-SP03-02N-439V-R27-L14

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ROHS Compliant

\*Sockets are not drawn to scale Nissha FIS, Inc., 02/20/2024



### **Terminals**

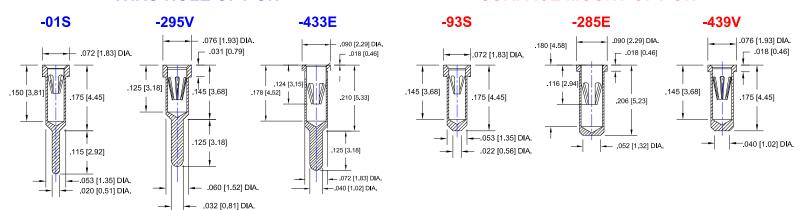


#### NISSHA FIS, Inc. Continued

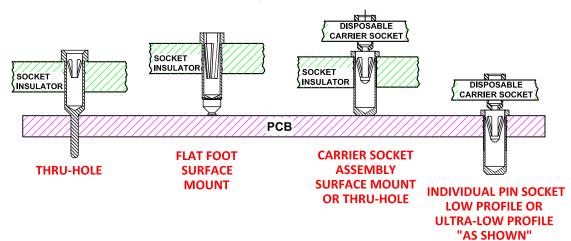
Top View Shown
Units: in [mm]

#### THRU HOLE OPTION

#### **SURFACE MOUNT OPTION**



# Socket &Terminal Options



# **Technical Information**

#### Material:

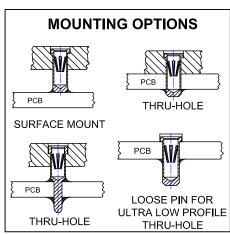
Insulator: Hi-Temp UL 94V-O Terminal: Brass, per ASTM-B16 Contact: BeCu. Per ASTM-B194 Plating: RoHS COMPLIANT

R27 TERMINAL: GOLD / CONTACT: GOLD

**OTHER PLATINGS AVAILABLE** 

Terminal Acceptance and Forces												
Thru Hole Terminals				Surface Mount Terminals								
Thru Hole Terminal	Accepts Pin Diameter	Insertion Force	Withdrawal Force	Surface Mount Terminal	Accepts Pin Diameter	Insertion Force	Withdrawal Force					
-01S	Ø.018 [Ø0.46]	9.0 oz Avg.	2.0 oz Min	-93S	Ø.018 [Ø0.46]	9.0 oz Avg.	2.0 oz Min					
-433E	Ø.040 [Ø1.02]	36.0 oz Avg.	3.9 oz Min	-285E	Ø.040 [Ø1.02]	36.0 oz Avg.	3.9 oz Min					
-295V	Ø.030 [Ø0.76]	13.2 oz Avg.	3.5 oz Min	-439V	Ø.030 [Ø0.76]	13.2 oz Avg.	3.5 oz Min					

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# Carrier Assembly Configurations



# For fast, accurate placement of SIP sockets and ultra-low profile terminals

Phase 1: Receive Carrier Assemblies designed to your pin layout.

**Before Soldering** 



Phase 2: Place carrier assemblies onto PCB; run through your soldering process.

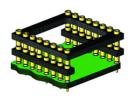


Phase 3:

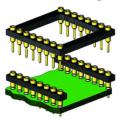
Remove carrier and plug in your device; discard carrier.

DIP Carrier SIP Sockets PCB



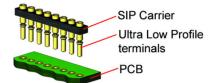


**After Soldering** 



#### **ULTRA-LOW PROFILE SIP**

**Before Soldering** 



### **During Soldering**

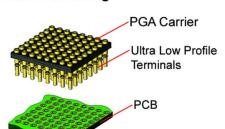


**After Soldering** 



#### **ULTRA-LOW PROFILE PGA**

**Before Soldering** 



**During Soldering** 

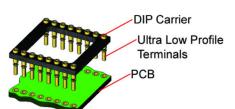


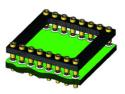
After Soldering



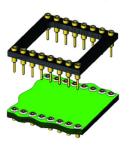
# ULTRA LOW PROFILE DIP During Soldering

**Before Soldering** 





**After Soldering** 



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